

RS-232 LINE DRIVER/RECEIVER AT 3.3 V/5 V

The μ PD4721 is a high-breakdown voltage silicon gate CMOS line driver/receiver based on the EIA/TIA-232-E standard. The internal DC/DC converter can switch between multiple voltages, realizing the allowing it to operate with a single +3.3 V or +5 V power supply. It also provides standby function.

This IC incorporates 2 driver circuits and 2 receiver circuits. An RS-232 interface circuit can be easily configured by connecting 5 capacitors externally.

FEATURES

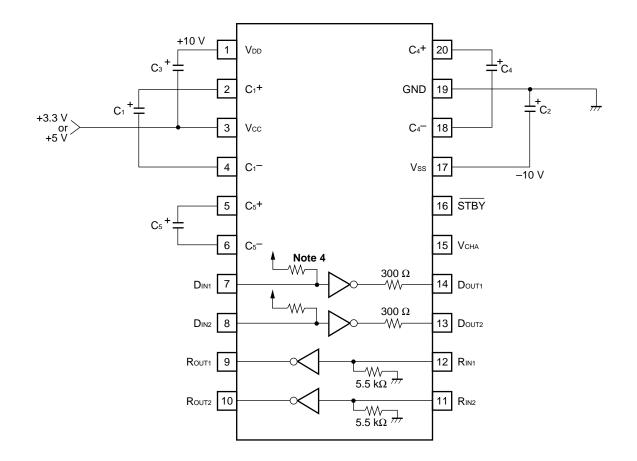
NEC

- Conforms to EIA/TIA-232-E (former name, RS-232C) standards
- Selectable +3.3 V/+5 V single power supply (selected by VCHA pin)
- By setting the standby pin to a low level (standby mode), circuit current can be reduced. At such times, the driver output is in a high-impedance state.

ORDERING INFORMATION

Part number	Package
μPD4721GS-GJG	20-pin plastic SSOP (300 mil)

BLOCK DIAGRAM/PIN CONFIGURATION (Top View)



- Note 1. VDD and Vss are output pins stepped up internally. These pins should not be loaded directly.
 - **2.** Capacitors C₁ to C₅ with a breakdown voltage of 20 V or higher are recommended. And it is recommended to insert the capacitor that is 0.1 μ F to 1 μ F between Vcc and GND.
 - 3. If $V_{CHA}\,is$ kept low level (in 5 V mode), capacitor C_5 is not necessary.
 - 4. The pull-up resistors at driver input are active resistors.

Truth Table

Driver

STBY	Din	Dout	Remarks
L	×	Z	Standby mode (DC/DC converter is stopped)
н	L	н	Space level output
н	н	L	Mark level output

Receiver

STBY	Rın	Rout	Remarks
L	×	н	Standby mode (DC/DC converter is stopped)
н	L	н	Mark level input
н	н	L	Space level input

3 V \leftrightarrow 5 V switching $^{\text{Note 5}}$

Vсна	Operating mode
L	5 V mode (double step-up)
н	3 V mode (3 times step-up)

H: high-level, L: low-level, Z: high-impedance, ×: H or L

Note 5. When switching V_{CHA}, standby mode must be selected ($\overline{\text{STBY}}$ = L).

ABSOLUTE MAXIMUM RATINGS (TA = 25 °C)

Parameter	Symbol	Ratings	Unit
Supply Voltage (VCHA = L)	Vcc	-0.5 to +7.0	V
Supply Voltage (VCHA = H)	Vcc	-0.5 to +4.5	V
Driver Input Voltage	Din	-0.5 to Vcc +0.5	V
Receiver Input Voltage	Rın	-30.0 to +30.0	V
Control Input Voltage (STBY, VCHA)	Vin	-0.5 to Vcc +0.5	V
Driver Output Voltage	Dout	-25.0 to +25.0 Note 6	V
Receiver Output Voltage	Rout	-0.5 to Vcc +0.5	V
Input Current (DIN, STBY, VCHA)	Іім	±20.0	mA
Operating Ambient Temperature	TA	-40 to +85	°C
Storage Temperature	Tstg	-55 to +150	°C
Total Power Dissipation	Рт	0.5	W

Note 6. Pulse width = 1 ms, duty = 10 % MAX.

RECOMMENDED OPERATING CONDITIONS

Parameter	Symbol	MIN.	TYP.	MAX.	Unit
Supply Voltage (V _{CHA} = L, 5 V mode)	Vcc	4.5	5.0	5.5	V
Supply Voltage (V _{CHA} = H, 3 V mode)	Vcc	3.0	3.3	3.6	V
High-Level Input Voltage (Dℕ)	Vін	2.0		Vcc	V
Low-Level Input Voltage (DIN)	VIL	0		0.8	V
High-Level Input Voltage (STBY, VCHA)	Vін	2.4		Vcc	V
Low-Level Input Voltage (STBY, VCHA)	VIL	0		0.6	V
Receiver Input Voltage	Rin	-30		+30	V
Operating Ambient Temperature	TA	-40		+85	°C
Capacitance of External Capacitor	Note 7	0.33		4.7	μF

Note 7. In low temperature (below 0 °C), the capacitance of electrolytic capacitor becomes lower. Therefore, set higher values when using in low temperature.

Concerning the wiring length between the capacitor and the IC, the shorter the better.

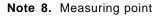
Capacitors with good frequency characteristics such as tantalum capacitors, laminated ceramic capacitors, and aluminum electrolytic capacitors for switching power supply are recommended for the external capacitors.

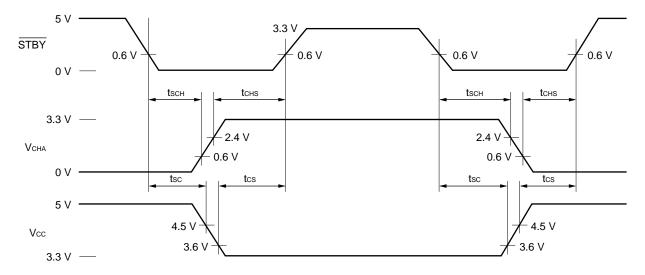
ELECTRICAL SPECIFICATIONS (TOTAL)

(Unless otherwise specified, $T_A = -40$ to +85 °C, C1 to C5 = 1 μ F)

Parameter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Circuit Current	Icc1	$\frac{V_{CC}}{STBY}$ = H		6.5	13	mA
		$\frac{V_{CC}}{STBY}$ = H		4.5	9	mA
Circuit Current	Icc2	$ V_{CC} = +3.3 \text{ V}, \text{R}_{L} = 3 \frac{\text{k}\Omega \text{ (Dout)}, \text{Din} = \text{GND}, } \\ \text{Rin, Rout pin OPEN, } \overline{\text{STBY}} = \text{H} $		19	24	mA
	1002	$ V_{CC} = +5.0 \text{ V,RL} = 3 \text{ k}\Omega \text{ (Dout), Din} = \text{GND,} \\ R_{IN}, \text{ Rout pin OPEN, } \overline{\text{STBY}} = H $		14	18	mA
		Vcc = +3.3 V, No load, DIN and RIN pins are OPEN, $\overline{\text{STBY}}$ = L, TA = 25 °C		1	3	μΑ
Circuit Current at Standby	Іссз	Vcc = +3.3 V, No load, DIN and RIN pins are OPEN, $\overline{\text{STBY}}$ = L		5		μA
Circuit Current at Standby	1003	V_{CC} = +5.0 V, No load, D _{IN} and R _{IN} pins are OPEN, STBY = L, T _A = 25 °C		2	5	μΑ
		V_{CC} = +5.0 V, No load, D _{IN} and R _{IN} pins are OPEN, \overline{STBY} = L		10		μΑ
High-Level Input Voltage	Vін	Vcc = +3.0 to +5.5 V, $\overline{\text{STBY}}$, Vcha pin	2.4			V
Low-Level Input Voltage	VIL	Vcc = +3.0 to +5.5 V, $\overline{\text{STBY}}$, Vcha pin			0.6	V
High-Level Input Current	Ін	V_{CC} = +5.5 V, V_I = +5.5 V, \overline{STBY} , V_{CHA} pin			1	μΑ
Low-Level Input Current	١L	$V_{CC} = +5.5 \text{ V}, \text{ VI} = 0 \text{ V}, \text{ STBY}, \text{ V}_{CHA} \text{ pin}$			-1	μΑ
Input Capacitance	CIN	Driver input and receiver input Vcc = +3.3 V, for GND, f = 1 MHz			10	pF
		Driver input and receiver input Vcc = +5.0 V, for GND, f = 1 MHz			10	pF
STBY — VCHA Time	tscн	Vcc = +3.0 to +5.5 V, $\overline{\text{STBY}} \downarrow \rightarrow \text{V}_{\text{CHA}},$ Note 8	1			μs
VCHA — STBY Time	tснs	V_{CC} = +3.0 to +5.5 V, $V_{\text{CHA}} \rightarrow \overline{\text{STBY}}$ $\uparrow,$ Note 8	1			μs
STBY — Vcc Time	tsc	Vcc = +3.0 to +5.5 V, $\overline{\text{STBY}} \downarrow \rightarrow \text{Vcc}$, Note 8	1			μs
$V_{CC} - \overline{STBY}$ Time	tcs	Vcc = +3.0 to +5.5 V, Vcc $\rightarrow \overline{\text{STBY}}$ ^, Note 8	1			μs

* The TYP. values are for reference at TA = 25 $^\circ\text{C}.$





ELECTRICAL SPECIFICATIONS (DRIVER)

(Unless otherwise specified, TA = -40 to +85 °C, C1 to C5 = 1 μ F)

Parameter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Low-Level Input Voltage	VIL				0.8	V
High-Level Input Voltage	VIH		2.0			V
Low-Level Input Current	lı∟	$V_{CC} = +3.6 V, V_{I} = 0 V$			-25	μΑ
High-Level Input Current	Ін	$V_{CC} = +3.6 V, V_{I} = 3.6 V$			1.0	μΑ
		Vcc = +3.3 V, $R_L = \infty$, $T_A = 25 \ ^{\circ}C$		±9.5		V
Output Voltage	Vdo	Vcc = +3.3 V, R _L = 3 k Ω , T _A = T _{opt}	±5.0	±6.0		V
		Vcc = +3.0 V, RL = 3 k Ω , TA = +25 °C	±5.0			V
Output Short-Circuit Current	lsc	Vcc = +3.3 V, for GND			±40	mA
Slew-Rate Note 9	SR	C_{L} = 10 pF, R_{L} = 3 to 7 $k\Omega$	3.0		30	V/µs
Siew-Itale	5K	C_{L} = 2 500 pF, R_{L} = 3 to 7 $k\Omega$	3.0		30	V/µs
Propagation Delay Time Note 9	tрні tplн	R_L = 3 k Ω , C_L = 2 500 pF		2.5		μs
Output Resistor	Ro	$V_{CC} = V_{DD} = V_{SS} = 0 V$ $V_{OUT} = \pm 2 V$	300			Ω
Standby Output Transfer Time	tdaz	R_{L} = 3 kΩ, C_{L} = 2 500 pF, $^{\text{Note 10}}$		4	10	μs
Standby Output Transfer Time	tdza	R_{L} = 3 kΩ, C_{L} = 2 500 pF, $^{\text{Note 10}}$		1	3	ms
Power-On Output Transfer Time	t pra	R_{L} = 3 kΩ, C_{L} = 2 500 pF, $^{\text{Note 11}}$		1	3	ms

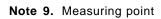
3 V mode (unless otherwise specified, VCHA = H, VCC = 3.0 to 3.6 V)

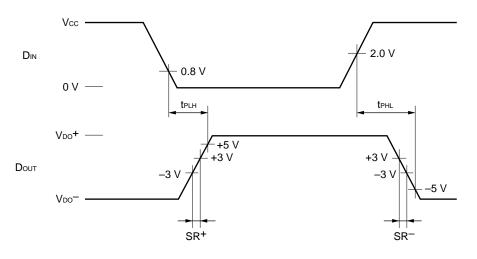
* The TYP. values are for reference at TA = 25 °C.

Parameter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Low-Level Input Voltage	VIL				0.8	V
High-Level Input Voltage	Vін		2.0			V
Low-Level Input Current	lı∟	$V_{CC} = +5.5 V, V_1 = 0 V$			-40	μΑ
High-Level Input Current	Ін	$Vcc = +5.5 V, V_1 = 5.5 V$			1.0	μΑ
		Vcc = +5.0 V, R _L = ∞ , T _A = 25 °C		±9.7		V
Output Voltage	Vdo	Vcc = +5.0 V, R_L = 3 k Ω , T_A = T_{opt}	±6.0			V
		Vcc = +4.5 V, R_L = 3 k Ω , T_A = T_{opt}	±5.0			V
Output Short-Circuit Current	lsc	Vcc = +5.0 V, for GND			±40	mA
		C_L = 10 pF, R_L = 3 to 7 $k\Omega$	4.0		30	V/µs
Slew-Rate Note 9	SR	C_L = 2 500 pF, R_L = 3 to 7 k Ω	4.0		30	V/µs
Propagation Delay Time Note 9	tрнг tргн	$R_L = 3 k\Omega$, $C_L = 2 500 pF$		2		μs
Output Resistor	Ro	$V_{CC} = V_{DD} = V_{SS} = 0 V$ $V_{OUT} = \pm 2 V$	300			Ω
Standby Output Transfer Time	tdaz	$R_L = 3 \ k\Omega, \ C_L = 2 \ 500 \ pF,^{Note \ 10}$		4	10	μs
Standby Output Transfer Time	t dza	$R_L = 3 \text{ k}\Omega, C_L = 2 \text{ 500 pF}, \text{Note 10}$		0.5	1	ms
Power-On Output Transfer Time	t pra	$R_L = 3 \text{ k}\Omega, C_L = 2 \text{ 500 pF}, ^{\text{Note 12}}$		0.5	1	ms

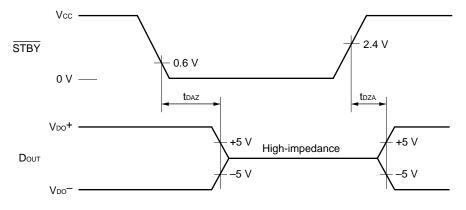
5 V mode (Unless otherwise specified	, VCHA = L, VCC = $+5.0 \text{ V} \pm 10 \text{ \%}$)
--------------------------------------	--

* The TYP. values are for reference at T_{A} = 25 $^{\circ}\text{C}.$



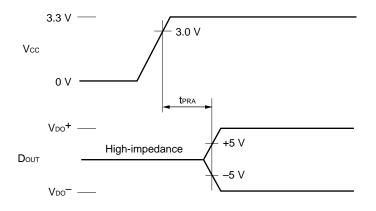


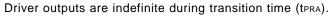
Note 10. Measuring point

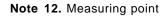


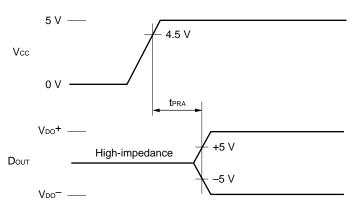
Driver outputs are indefinite during transition time (tDZA).

Note 11. Measuring point









Driver outputs are indefinite during transition time (tpra).

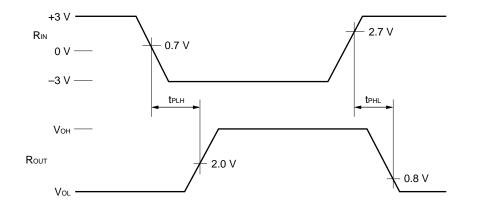
ELECTRICAL SPECIFICATIONS (RECEIVER)

(Unless otherwise specified, Vcc = 3.0 to 5.5 V, TA = -40 to +85 °C, C1 to C5 = 1 μ F)

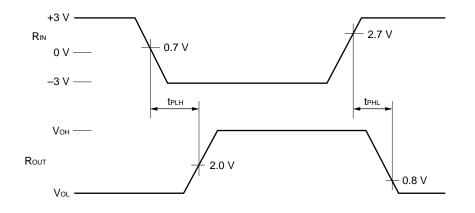
Parameter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Low-Level Output Voltage	Vol1	louτ = 4 mA, STBY = H			0.4	V
High-Level Output Voltage	V _{OH1}	louτ = -4 mA, STBY = H	Vcc – 0.4			V
Low-Level Output Voltage	Vol2	louτ = 4 mA, STBY = L			0.5	V
High-Level Output Voltage	Vон2	lout = -4 mA, $\overline{\text{STBY}}$ = L	Vcc – 0.5			V
Propagation Delay Time (STBY = H)	tрні tplh	$\label{eq:Rin} \begin{array}{l} R_{\text{IN}} \rightarrow R_{\text{OUT}}, \ CL = 150 \ pF \\ V_{\text{CC}} = +3.0 \ V, \ ^{\text{Note 13}} \end{array}$		0.2		μs
Input Resistor	Ri		3	5.5	7	kΩ
Input Pin Open Voltage	Vio				0.5	V
	VIH	Vcc = +3.0 to +5.5 V	1.7	2.3	2.7	V
Input Threshold ($\overline{STBY} = H$)	VIL	Vcc = +3.0 to +5.5 V	0.7	1.1	1.7	V
	Vн	Vcc = +3.0 to +5.5 V (Hysteresis width)	0.5	1.2	1.8	V
Standby Output Transfer Time	tdah	Note 15		0.2	3	μs
Standby Output Transfor Time	t	V _{CHA} = H (3 V mode) ^{Note 15}		0.6	3	ms
Standby Output Transfer Time	tdha	VCHA = L (5 V mode) Note 15		0.3	1	ms
Dower On Depot Delegan Time	4	VCHA = H (3 V mode) Note 16		1	3	ms
Power-On Reset Release Time	t pra	V _{CHA} = L (5 V mode) Note 17		0.5	1	ms

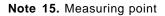
* The TYP. values are for reference at TA = 25 °C.

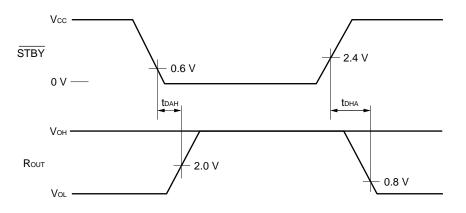
Note 13. Measuring point



Note 14. Measuring point

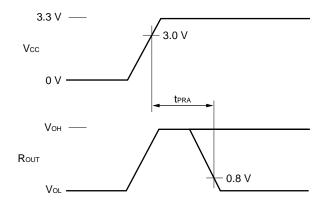






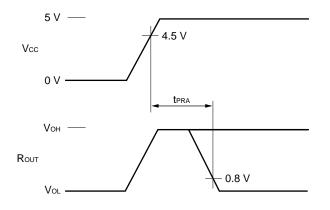
Receiver outputs are indefinite during transition time (tDHA).

Note 16. Measuring point



Receiver outputs are indefinite during reset release time (tPRA).

Note 17. Measuring point



Receiver outputs are indefinite during reset release time (tPRA).

REFERENCE MATERIAL

- IC PACKAGE MANUAL (C10943X)
- NEC SEMICONDUCTOR DEVICE RELIABILITY/QUALITY (IEI-1212)

RECOMMENDED SOLDERING CONDITIONS

The following conditions (See table below) must be met when soldering this product.

Please consult with our sales offices in case other soldering process is used, or in case soldering is done under different conditions.

TYPES OF SURFACE MOUNT DEVICE

For more details, refer to our document "SMT MANUAL" (C10535E).

μ PD4721 GS-GJG

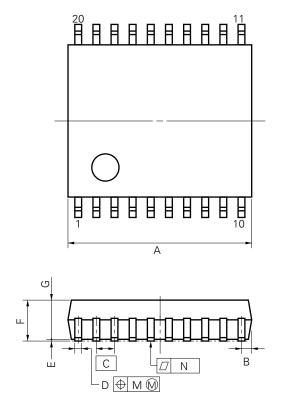
Soldering process	Soldering conditions	Symbol
Infrared ray reflow	Peak package's surface temperature: 230 °C or below, Reflow time: 30 seconds or below (210 °C or higher), Number of reflow process: 2, Exposure limit*: None	IR30-00-2
VPS	Peak package's surface temperature: 215 °C or below, Reflow time: 40 seconds or below (200 °C or higher), Number of reflow process: 2, Exposure limit*: None	VP15-00-2
Wave soldering	Solder Temperature: 260 °C or lower, Reflow time: Within 10 sec, Number of reflowprocess: 1, Exposure limit*: None	WS60-00-1
Partial heating method	Terminal temperature: 300 °C or below, Flow time: 10 seconds or below, Exposure limit*: None	0

* Exposure limit before soldering after dry-pack package is opened. Storage conditions: 25 °C and relative humidity at 65 % or less.

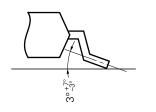
Note Do not apply more than a single process at once, except for "Partial heating method"

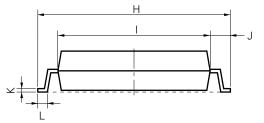
PACKAGE DRAWINGS

20 PIN PLASTIC SHRINK SOP (300 mil)



detail of lead end





NOTE

Each lead centerline is located within 0.12 mm (0.005 inch) of its true position (T.P.) at maximum material condition.

		P20GM-65-300B-2
ITEM	MILLIMETERS	INCHES
A	7.00 MAX.	0.276 MAX.
В	0.575 MAX.	0.023 MAX.
С	0.65 (T.P.)	0.026 (T.P.)
D	0.30±0.10	$0.012^{+0.004}_{-0.005}$
E	0.125±0.075	0.005±0.003
F	2.0 MAX.	0.079 MAX.
G	1.7	0.067
н	8.1±0.3	0.319±0.012
1	6.1±0.2	0.240±0.008
J	1.0±0.2	0.039 ^{+0.009} _{-0.008}
К	$0.15\substack{+0.10 \\ -0.05}$	0.006+0.004
L	0.5±0.2	0.020 ^{+0.008} -0.009
М	0.12	0.005
N	0.10	0.004

[MEMO]

No part of this document may be copied or reproduced in any form or by any means without the prior written consent of NEC Corporation. NEC Corporation assumes no responsibility for any errors which may appear in this document.

NEC Corporation does not assume any liability for infringement of patents, copyrights or other intellectual property rights of third parties by or arising from use of a device described herein or any other liability arising from use of such device. No license, either express, implied or otherwise, is granted under any patents, copyrights or other intellectual property rights of NEC Corporation or others.

While NEC Corporation has been making continuous effort to enhance the reliability of its semiconductor devices, the possibility of defects cannot be eliminated entirely. To minimize risks of damage or injury to persons or property arising from a defect in an NEC semiconductor device, customers must incorporate sufficient safety measures in its design, such as redundancy, fire-containment, and anti-failure features.

NEC devices are classified into the following three quality grades:

"Standard", "Special", and "Specific". The Specific quality grade applies only to devices developed based on a customer designated "quality assurance program" for a specific application. The recommended applications of a device depend on its quality grade, as indicated below. Customers must check the quality grade of each device before using it in a particular application.

- Standard: Computers, office equipment, communications equipment, test and measurement equipment, audio and visual equipment, home electronic appliances, machine tools, personal electronic equipment and industrial robots
- Special: Transportation equipment (automobiles, trains, ships, etc.), traffic control systems, anti-disaster systems, anti-crime systems, safety equipment and medical equipment (not specifically designed for life support)
- Specific: Aircrafts, aerospace equipment, submersible repeaters, nuclear reactor control systems, life support systems or medical equipment for life support, etc.

The quality grade of NEC devices is "Standard" unless otherwise specified in NEC's Data Sheets or Data Books. If customers intend to use NEC devices for applications other than those specified for Standard quality grade, they should contact an NEC sales representative in advance.

Anti-radioactive design is not implemented in this product.